

1.5V Drive Pch MOSFET

RW1A025AP

Structure

Silicon P-channel MOSFET

Features

- 1) Low On-resistance.
- 2) Small high power package.
- 3) Low voltage drive.(1.5V)

Application

Switching

Packaging specifications

•	Package	Taping	
Type	Code	T2CR	
	Basic ordering unit (pieces)	8000	
RW1A025A	0		

● Absolute maximum ratings (Ta = 25°C)

Parame	Symbol	Limits	Unit	
Drain-source voltage		V_{DSS}	-12	V
Gate-source voltage		V_{GSS}	0 to -8	V
Drain current	Continuous	I_D	±2.5	Α
	Pulsed	I _{DP} *1	±7.5	Α
Source current	Continuous	I _S	-0.5	Α
(Body Diode)	Pulsed	I _{SP} *1	-7.5	Α
Power dissipation		P _D *2	0.7	W
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg	-55 to +150	°C

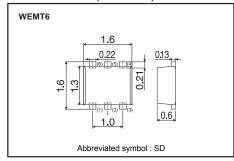
^{*1} Pw≤10µs, Duty cycle≤1%

● Thermal resistance

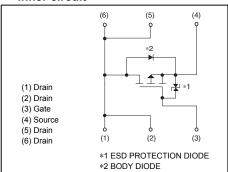
Parameter	Symbol	Limits	Unit
Channel to Ambient	Rth (ch-a)*	179	°C/W

^{*}Mounted on a ceramic board.

● Dimensions (Unit : mm)



• Inner circuit



^{*2} Mounted on a ceramic board.

● Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	1	-	-10	μA	V_{GS} =-8V, V_{DS} =0V
Drain-source breakdown voltage	$V_{(BR)DSS}$	-12	-	-	٧	I _D =-1mA, V _{GS} =0V
Zero gate voltage drain current	I _{DSS}	1	-	-10	μA	V _{DS} =-12V, V _{GS} =0V
Gate threshold voltage	V _{GS (th)}	-0.3	-	-1.0	٧	V_{DS} =-6V, I_{D} =-1mA
		1	44	62	mΩ	I _D =-2.5A, V _{GS} =-4.5V
Static drain-source on-state	R *	1	55	77		I _D =-1.2A, V _{GS} =-2.5V
resistance	R _{DS (on)}	-	75	110	1115.2	I _D =-1.2A, V _{GS} =-1.8V
		-	90	180		I _D =-0.5A, V _{GS} =-1.5V
Forward transfer admittance	IY _{fs} I*	3.5	-	-	S	I _D =-2.5A, V _{DS} =-6V
Input capacitance	C _{iss}	1	2000	-	pF	V _{DS} =-6V
Output capacitance	C _{oss}	1	130	-	pF	V _{GS} =0V
Reverse transfer capacitance	C _{rss}	1	120	-	pF	f=1MHz
Turn-on delay time	t _{d(on)} *	1	11	-	ns	I _D =-1.2A, V _{DD} ≒-6V
Rise time	t _r *	ı	40	-	ns	V _{GS} =-4.5V
Turn-off delay time	t _{d(off)} *	-	160	-	ns	$R_L=5\Omega$
Fall time	t _f *	-	60	-	ns	R_G =10 Ω
Total gate charge	Q _g *	-	16	-	nC	I _D =-2.5A
Gate-source charge	Q _{gs} *	-	2.4	-	nC	V _{DD} ≒–6V
Gate-drain charge	Q _{gd} *	-	2.2	-	nC	V _{GS} =-4.5V

^{*}Pulsed

●Body diode characteristics (Source-Drain) (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward Voltage	V _{SD} *	-	-	-1.2	V	I _s =-2.5A, V _{GS} =0V

^{*}Pulsed

●Electrical characteristic curves (Ta=25°C)

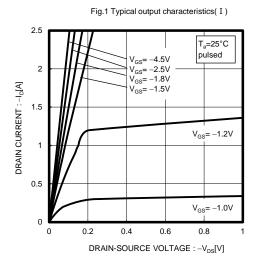


Fig.3 Typical Transfer Characteristics

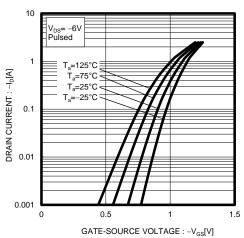


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current(II)

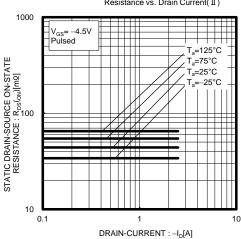


Fig.2 Typical output characteristics(${\rm I\hspace{-.1em}I}$) 2.5 T_a=25°C pulsed 2 DRAIN CURRENT: -I_D[A] 1.5 V_{GS}= -4.5V $V_{GS} = -2.5V$ $V_{GS} = -1.8V$ 1 V_{GS}= -1.5V 0.5 $V_{GS} = -1.0V$ 0 0 6 10

Fig.4 Static Drain-Source On-State Resistance vs. Drain Current(I)

DRAIN-SOURCE VOLTAGE : $-V_{DS}[V]$

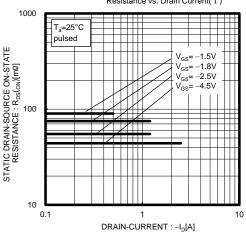
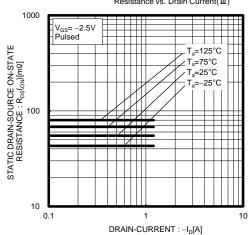
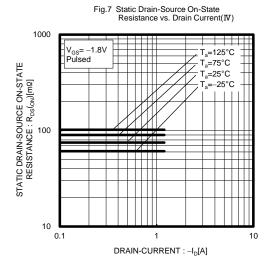
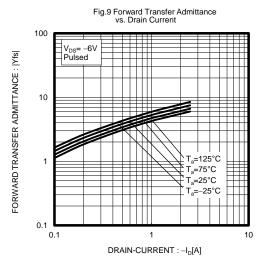
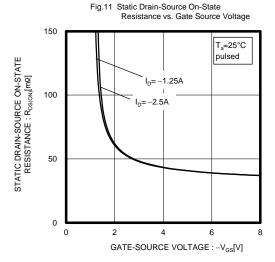


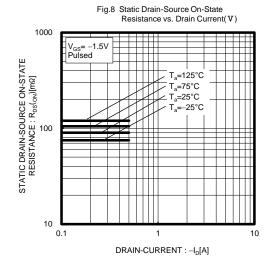
Fig.6 Static Drain-Source On-State Resistance vs. Drain Current(Ⅲ)

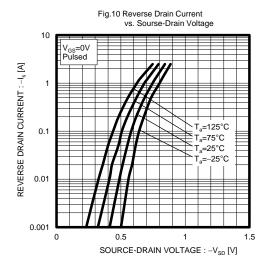


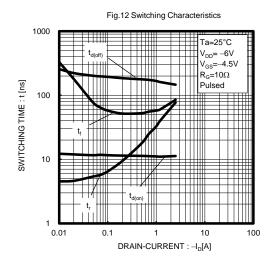


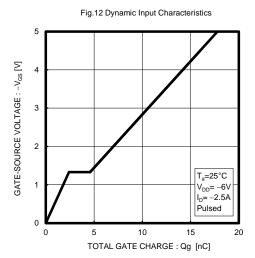


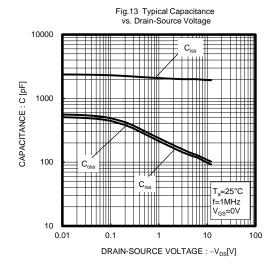












Measurement circuits

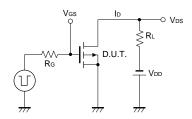


Fig.1-1 Switching Time Measurement Circuit

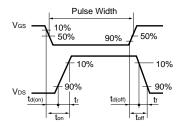


Fig.1-2 Switching Waveforms

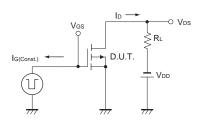


Fig.2-1 Gate Charge Measurement Circuit

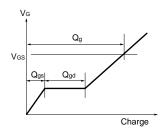


Fig.2-2 Gate Charge Waveform

Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

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